

Features

- Fast Switching Speed
- Ultra-Small Surface Mount Package
- IEC 61000-4-2 Contact Method: $\pm 15\text{kV}$
- IEC 61000-4-2 Air Discharge Method: $\pm 25\text{kV}$
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen- and Antimony-Free. "Green" Device (Note 3)**
- **For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at <https://www.diodes.com/products/automotive/automotive-products/>.**
- **This part is qualified to JEDEC standards (as references in AEC-Q) for High-Reliability.**
<https://www.diodes.com/quality/product-definitions/>

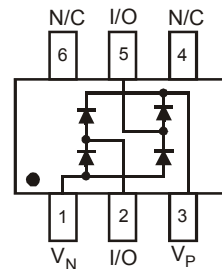
Mechanical Data

- Case: SOT-363
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Finish—Matte Tin annealed over Alloy 42 Lead-Frame. Solderable per MIL-STD-202, Method 208 $\text{\textcircled{3}}$
- Weight: 0.006 grams (Approximate)



Top View

SOT-363



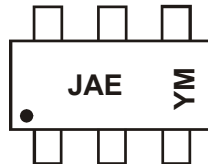
Device Schematic

Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
DLPA004-7	Standard	SOT-363	3000/Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information



JAE = Product Type Marking Code
 YM = Date Code Marking
 Y = Year (ex: V = 2020)
 M = Month (ex: 9 = September)

Date Code Key

Year	2008	2020	2021	2022	2023	2024	2025
Code	V	H	I	J	K	L	M

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	85	V
RMS Reverse Voltage	$V_{R(RMS)}$	60	V
Forward Current (Single Diode)	I_{FM}	200	mA
Repetitive Peak Forward Current	I_{FRM}	450	mA
Non-Repetitive Peak Forward Surge Current	I_{FSM}	@ $t = 1.0\mu\text{s}$ 4.0	A
		@ $t = 1.0\text{ms}$ 1.0	
		@ $t = 1.0\text{s}$ 0.5	

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P_D	200	mW
Thermal Resistance Junction to Ambient Air (Note 5)	$R_{\theta JA}$	625	$^\circ\text{C}/\text{W}$
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +150	$^\circ\text{C}$

Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	$V_{(BR)R}$	85	—	—	V	$I_R = 100\mu\text{A}$
Forward Voltage	V_F	—	—	0.80 0.90 1.0 1.25	V	$I_F = 1.0\text{mA}$ $I_F = 10\text{mA}$ $I_F = 50\text{mA}$ $I_F = 150\text{mA}$
Leakage Current (Note 6)	I_R	—	—	2.5 30 50	μA	$V_R = 70\text{V}$ $V_R = 25\text{V}, T_J = 150^\circ\text{C}$ $V_R = 70\text{V}, T_J = 150^\circ\text{C}$
Total Capacitance (per element)	C_T	—	2	—	pF	$V_R = 0, f = 1.0\text{MHz}$
Capacitance Between Two Data Lines (DL ₁ & DL ₂ , DL ₁ & DL ₃)	C_{LL}	—	1.6	2.0	pF	$V_R = 0, f = 1.0\text{MHz}$
Capacitance Between Data Line and Ground	C_{LG}	—	2.3	3.0	pF	$V_R = 0, f = 1.0\text{MHz}$
Reverse Recovery Time	t_{rr}	—	—	3.0	μs	$I_F = I_R = 10\text{mA}$, $I_{rr} = 0.1 \times I_R, R_L = 100\Omega$

Notes: 5. Device mounted on FR-4 PCB, 1.5 inch x 1.5 inch; 2oz copper with 1" x 1" pad layout.
6. Short duration pulse test used to minimize self-heating effect.

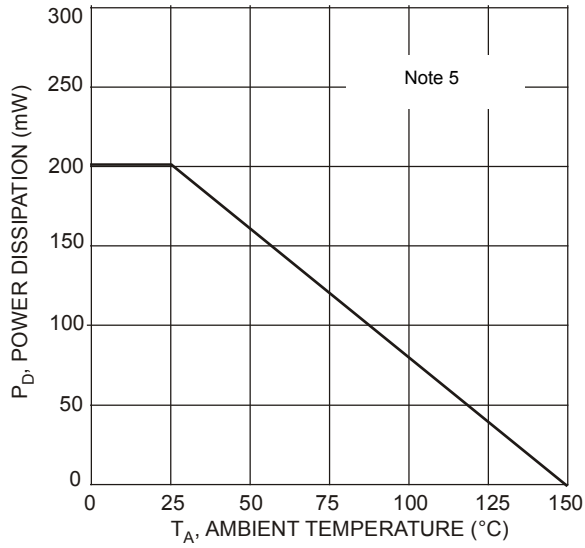


Fig. 1 Power Derating Curve, Total Package

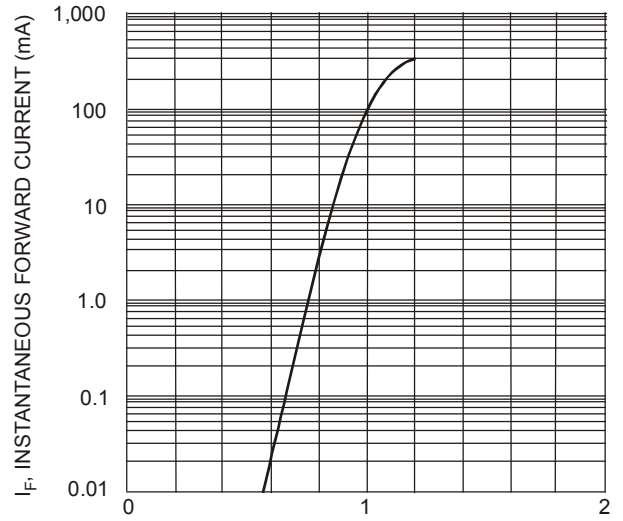


Fig. 2 Typical Forward Characteristics, Per Element

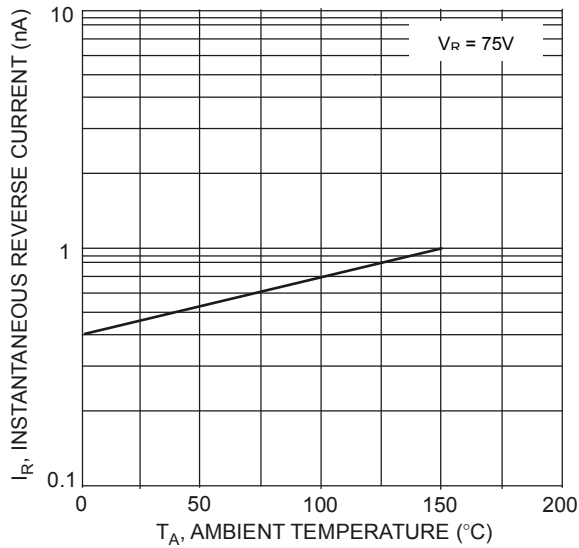
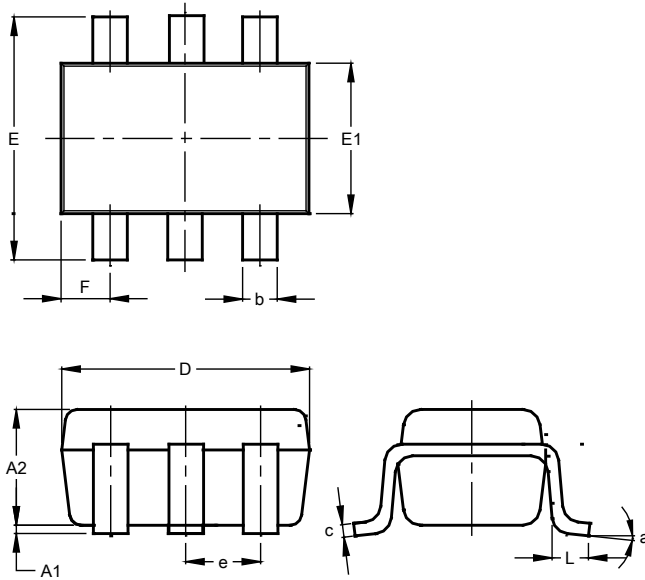


Fig. 3 Typical Reverse Characteristics, Per Element

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT363

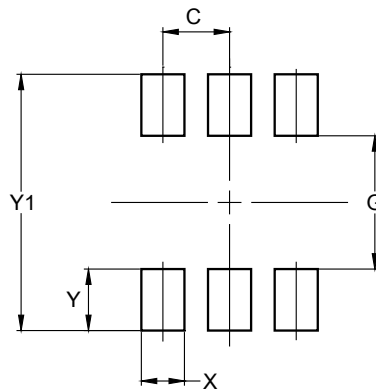


SOT363			
Dim	Min	Max	Typ
A1	0.00	0.10	0.05
A2	0.90	1.00	0.95
b	0.10	0.30	0.25
c	0.10	0.22	0.11
D	1.80	2.20	2.15
E	2.00	2.20	2.10
E1	1.15	1.35	1.30
e	0.650 BSC		
F	0.40	0.45	0.425
L	0.25	0.40	0.30
a	0°	8°	--
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT363



Dimensions	Value (in mm)
C	0.650
G	1.300
X	0.420
Y	0.600
Y1	2.500

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